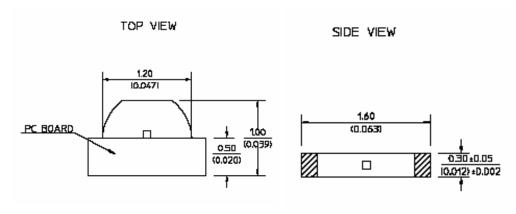
# Avago ASMT-CB30 0.3mm Right Angle Surface Mount ChipLED InGaN Blue

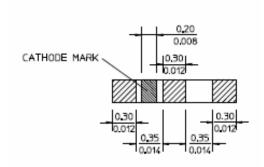


# **Datasheet**

# **Package Dimension**



### TERMINAL VIEW



#### NOTES

- 1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
- 2. TOLERANCE IS  $\pm$  0.1 mm ( $\pm$  0.004 IN.) UNLESS OTHERWISE SPECIFIED.

### **Device Selection Guide**

Package Dimension (mm)	Parts per Reel	Package Description
1.6 (L) x 1.0 (W) x 0.3 (H)	4000	Untinted, Diffused

**CAUTION:** ASMT-CB30 LEDs are Class 1A ESD sensitive per JESD22-A114C.01. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.



# Absolute Maximum Ratings at T<sub>A</sub> = 25°C

Parameter	ASMT-CB30	Unit
DC Forward Current [1]	10	mA
Power Dissipation	32	mW
Reverse Voltage (I <sub>R</sub> = 100μA)	5	V
LED Junction Temperature	95	°C
Operating Temperature Range	-40 to 85	°C
Storage Temperature Range	-40 to 85	°C
Soldering Temperature	See reflow soldering profile (Figure 7 & 8)	

### Note:

Derate linearly as shown in Figure 4.

### Electrical Characteristics at T<sub>A</sub> = 25°C

	Forward Voltag	je	Reverse Breakdown
	V <sub>F</sub> (Volts) [1]		V <sub>R</sub> (Volts)
	@ $I_F = 5mA$		@ $I_R = 100 \mu A$
Part Number	Typical	Maximum	Minimum
ASMT-CB30	2.85	3.15	5

### Notes:

1. Vf tolerance: ±0.1V

# Optical Characteristics at T<sub>A</sub> = 25°C

	Lumino	us Intensity			Peak	Viewing Angle
	lv [1] (mcd)		Dominar	nt Wavelength,	Wavelength	<b>2 θ</b> <sub>1/2</sub> <sup>[3]</sup>
	@ 5mA		$\lambda_{d^{[2]}}$	it wavelength,	$\lambda_{\text{peak}}$ (nm)	(Degrees)
Part Number	Min.	Тур.	Min	Max	Тур.	Typical
ASMT-CB30	11.2	15.0	460.0	480.0	464	120

### Notes:

- 1. The luminous intensity  $I_V$  is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.
- 2. The dominant wavelength,  $\lambda_d$ , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- 3.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is  $\frac{1}{2}$  the peak intensity.



# Light Intensity (I<sub>V</sub>) Bin Limits

	Intensity (mcd	d)
Bin ID	Minimum	Maximum
L	11.20	18.00
M	18.00	28.50
N	28.50	45.00
Р	45.00	71.50

Tolerance: ±15%

# Forward Voltage (V<sub>F</sub>) Bin Limits

	Forward Voltage (V)	
Bin ID	Minimum	Maximum
1	2.55	2.75
2	2.75	2.95
3	2.95	3.15

Tolerance: ±0.1V

### **Color Bin Limits**

	Dominant Wa	Dominant Wavelength (nm)	
Bin ID	Minimum	Maximum	
А	460.0	465.0	
В	465.0	470.0	
С	470.0	475.0	
D	475.0	480.0	

Tolerance: ±1nm

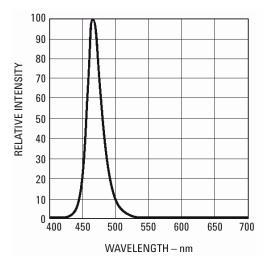


Figure 1. Relative Intensity vs. Wavelength

#### Notes:

- Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.
- 2. The lv binning specification set-up is for lowest allowable lv binning only. There is no upper lv bin limits.

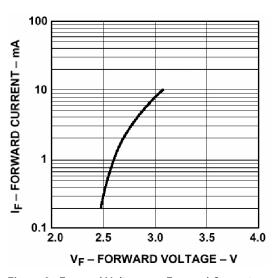


Figure 2. Forward Voltage vs. Forward Current



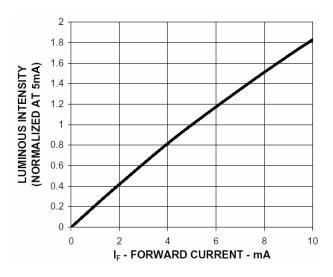
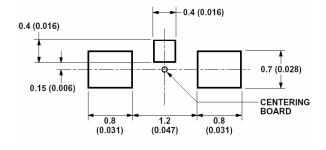


Figure 3. Luminous Intensity vs. Forward Current

Figure 4. Maximum Forward Current vs. Ambient Temperature



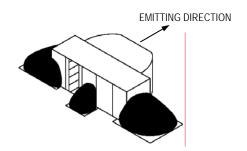


Figure 5. Recommended soldering land pattern

## Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1$ mm ( $\pm 0.004$ in.) unless otherwise specified.

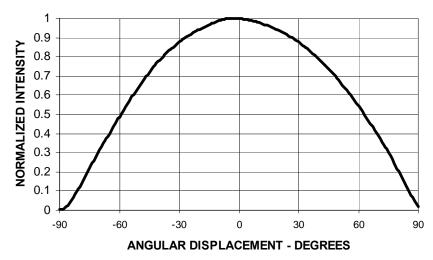
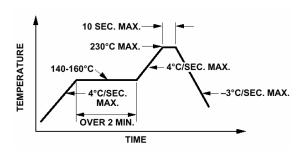


Figure 6. Relative intensity vs. angle.





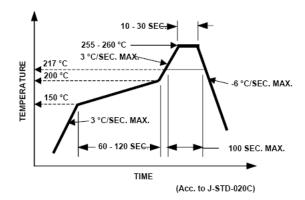


Figure 7. Recommended Reflow Soldering Profile

Figure 8. Recommended Pb-Free Reflow Soldering Profile

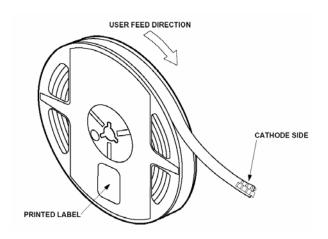


Figure 9. Reeling orientation.

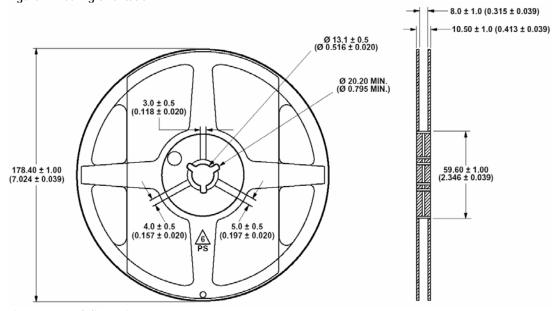


Figure 10. Reel dimensions.

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1$ mm ( $\pm 0.004$ in.) unless otherwise specified.

For product information and a complete list of distributors, please go to our web site: www.avagotech.com



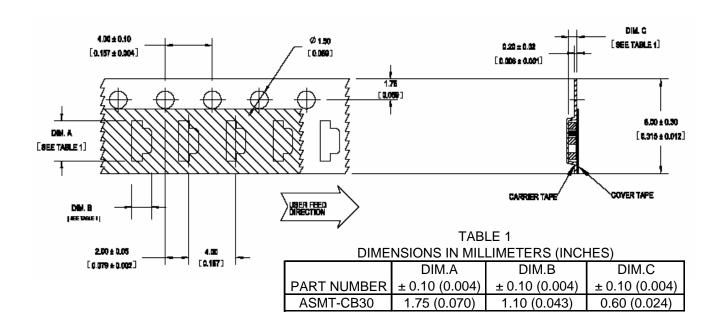


Figure 11. Tape dimensions.

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1$ mm ( $\pm 0.004$ in.) unless otherwise specified.

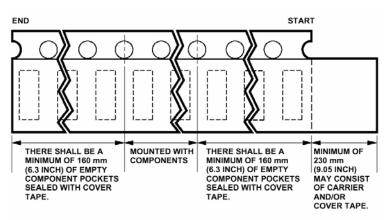


Figure 12. Tape leader and trailer dimensions.

## **Reflow Soldering:**

For more information on reflow soldering, refer to Application Note AN-1060, Surface Mounting SMT LED Indicator Components.

### Storage Condition:

5 to 30°C @ 60%RH max.

Baking is required before mounting, if:

- 1. Humidity Indicator Card is > 10% when read at 23  $\pm$  5°C.
- 2. Device expose to factory conditions <30°C/60%RH more than 672 hours.

Recommended baking condition: 60±5°C for 20 hours.



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Avago Technologies:

ASMT-CB30